



M.S.KENNEDY CORP.

HIGH SPEED, BUFFER AMPLIFIER AMP

0002

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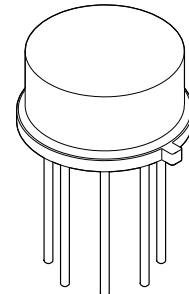
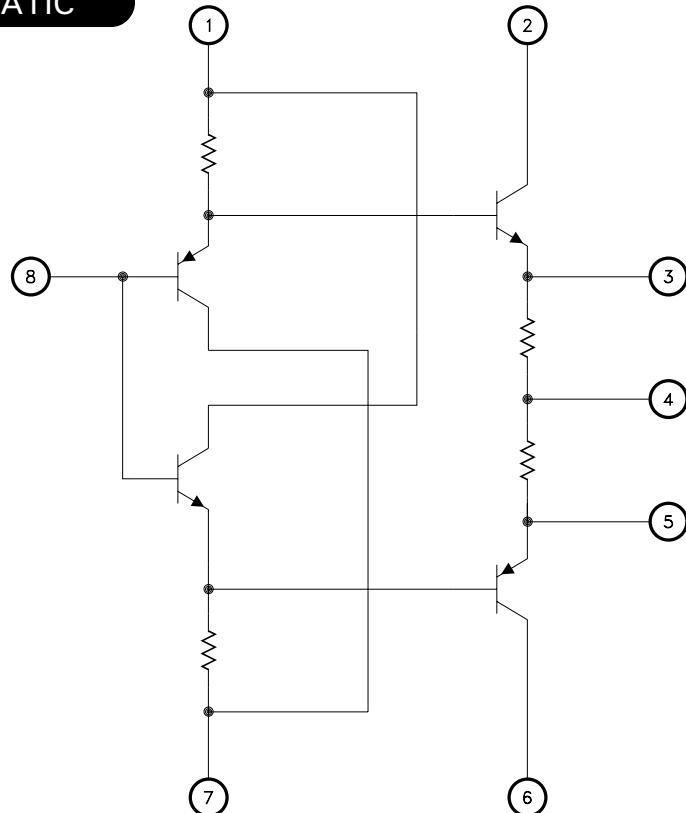
MIL-PRF-38534 CERTIFIED

FEATURES:

- Industry Wide LH0002 Replacement
- High Input Impedance-180KΩ Min
- Low Output Impedance-10Ω Max
- Low Harmonic Distortion
- DC to 30 MHz Bandwidth
- Slew Rate is Typically 400 V/µS
- Operating Range from ±5V to ±20V
- Available to DSCC SMD5962-7801301XC

DESCRIPTION:

The MSK 0002 is a general purpose current amplifier. It is the industry wide replacement for the LH0002. The device is ideal for use with an operational amplifier in a closed loop configuration to increase current output. The MSK 0002 is designed with a symmetrical output stage that provides low output impedances to both the positive and negative portions of output pulses. The MSK 0002 is packaged in a hermetic 8 lead low profile TO-5 header and is specified over the full military temperature range.

**EQUIVALENT SCHEMATIC****TYPICAL APPLICATIONS**

- High Speed D/A Conversion
- 30MHz Buffer
- Line Driver
- Precision Current Source

PIN-OUT INFORMATION

1	V1 +	5	E4
2	V2 +	6	V2-
3	E3	7	V1-
4	Output	8	Input

ABSOLUTE MAXIMUM RATINGS

$\pm V_{CC}$	Supply Voltage	$\pm 22V$	T_{ST}	Storage Temperature Range	-65°C to +150°C
V_{IN}	Input Voltage	$\pm 22V$	T_{LD}	Lead Temperature Range	+300°C (10 Seconds)
P_d	Power Dissipation	600mW	T_J	Junction Temperature	+175°C
T_c	Case Operating Temperature (MSK 0002H)	-55°C to +125°C	θ_{JC}	Thermal Resistance	40°C/W
	(MSK 0002)	-40°C to +85°C			

ELECTRICAL SPECIFICATIONS

Parameter	Test Conditions ①	Group A Subgroup	MSK 0002H ④			MSK 0002			Units
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Quiescent Current	$V_{IN} = 0V$ $R_s = 10K\Omega$ $R_L = 1.0K\Omega$	1	-	± 6.3	± 10	-	± 6.3	± 10	mA
Input Offset Current	$R_s = 10K\Omega$ $R_L = 1.0K\Omega$	1	-	± 2	± 10	-	± 2	± 10	μA
		2,3	-	± 2	± 10	-	-	-	μA
Input Offset Voltage	$R_s = 300\Omega$ $R_L = 1.0K\Omega$	1	-	± 6	± 30	-	± 6	± 30	mV
		2,3	-	± 10	± 30	-	-	-	mV
Input Impedance ③	$V_{IN} = 1.0V_{RMS}$ $R_s = 200K\Omega$ $R_L = 1K\Omega$ $f = 1.0KHz$	4	180	-	-	180	-	-	K Ω
Output Impedance ③	$V_{IN} = 1.0V_{RMS}$ $R_s = 10K\Omega$ $R_L = 50\Omega$ $f = 1.0KHz$	4	-	-	10	-	-	10	Ω
Output Voltage Swing	$V_{IN} = \pm 12V_p$ $R_L = 1.0K\Omega$ $f = 1.0KHz$	4	± 10	± 11	-	± 10	± 11	-	V p
	$V_{IN} = \pm 10V_p$ $R_L = 100\Omega$ $+V_{CC} = \pm 15V$ $f = 1.0KHz$	4	± 9.5	-	-	± 9.5	-	-	V p
Voltage Gain ②	$V_{IN} = 3.0V_{PP}$ $f = 1.0KHz$	4	0.95	0.97	-	0.95	0.97	-	V/V
	$R_s = 10K\Omega$ $R_L = 1.0K\Omega$	5,6	0.95	-	-	-	-	-	V/V
Rise Time	$V_{OUT} = 2.5V_{PP}$ $f = 10KHz$ $R_s = 100\Omega$ $R_L = 50\Omega$	4	-	8	12	-	8	12	nS

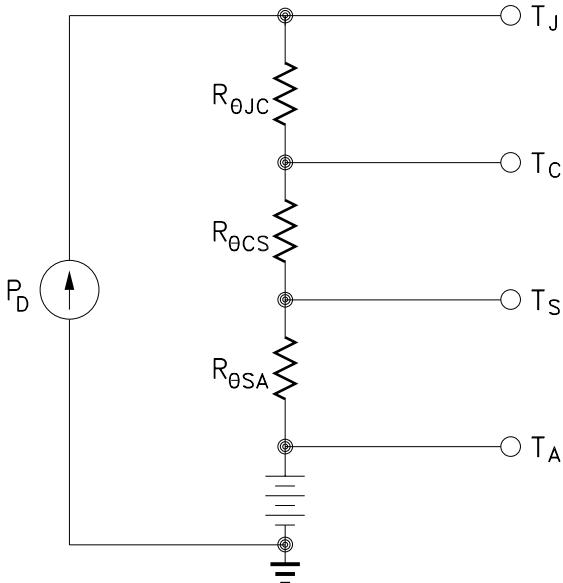
NOTES:

- ① Unless otherwise specified $\pm V_{CC} = \pm 12VDC$
- ② Subgroups 5 & 6 shall be tested as part of device initial characterization and after design and process changes. Parameter shall be guaranteed to the limits specified for subgroups 5 & 6 for all lots not specifically tested.
- ③ Devices shall be capable of meeting the parameter, but need not be tested.
- ④ Subgroup 1,4 $T_A = T_C = + 25^{\circ}C$
Subgroup 2,5 $T_A = T_C = + 125^{\circ}C$
Subgroup 3,6 $T_A = T_C = -55^{\circ}C$

HEAT SINKING

To determine if a heat sink is necessary for your application and if so, what type, refer to the thermal model and governing equation below.

Thermal Model:



Governing Equation:

$$T_J = P_D \times (R_{\theta JC} + R_{\theta CS} + R_{\theta SA}) + T_A$$

Where

T_J = Junction Temperature

P_D = Total Power Dissipation

$R_{\theta JC}$ = Junction to Case Thermal Resistance

$R_{\theta CS}$ = Heat Sink to Ambient Thermal Resistance

T_C = Case Temperature

T_A = Ambient Temperature

T_S = Sink Temperature

Example:

This example demonstrates a worst case analysis for the buffer output stage. This occurs when the output voltage is 1/2 the power supply voltage. Under this condition, maximum power transfer occurs and the output is under maximum stress.

Conditions:

$V_{CC} = \pm 12VDC$

$V_O = \pm 6Vp$ Sine Wave, Freq. = 1KHz

$R_L = 100\Omega$

For a worst case analysis we will treat the $\pm 6Vp$ sine wave as an 6 VDC output voltage.

1.) Find Driver Power Dissipation

$$\begin{aligned} PD &= (V_{CC}-V_O)(V_O/R_L) \\ &= (12V-6V)(6V/100\Omega) \\ &= 360mW \end{aligned}$$

2.) For conservative design, set $T_J = +125^{\circ}C$ Max.

3.) For this example, worst case $T_A = +80^{\circ}C$

4.) $R_{\theta JC} = 40^{\circ} C/W$ from MSK 0002H Data Sheet

5.) $R_{\theta CS} = 0.15^{\circ} C/W$ for most thermal greases

6.) Rearrange governing equation to solve for $R_{\theta SA}$

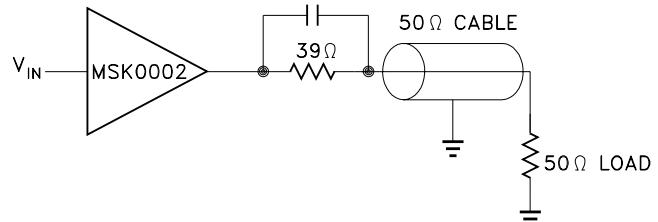
$$\begin{aligned} R_{\theta SA} &= ((T_J - T_A)/P_D) - (R_{\theta JC}) - (R_{\theta CS}) \\ &= ((125^{\circ}C - 80^{\circ}C) / 0.36W) - 40^{\circ}C/W - 0.15^{\circ}C/W \\ &= 125 - 40.15 \\ &= 84.9^{\circ}C/W \end{aligned}$$

This heat sink in this example must have a thermal resistance of no more than $84.9^{\circ}C/W$ to maintain a junction temperature of no more than $+125^{\circ}C$.

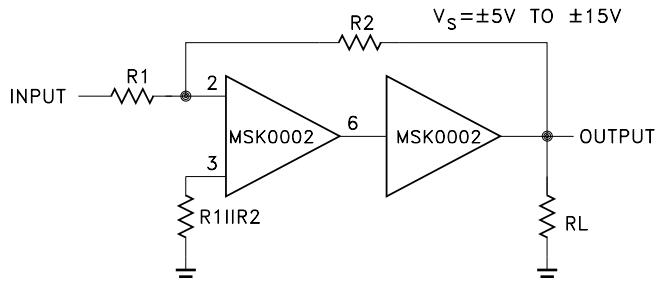
Typical Applications:

LINE DRIVER

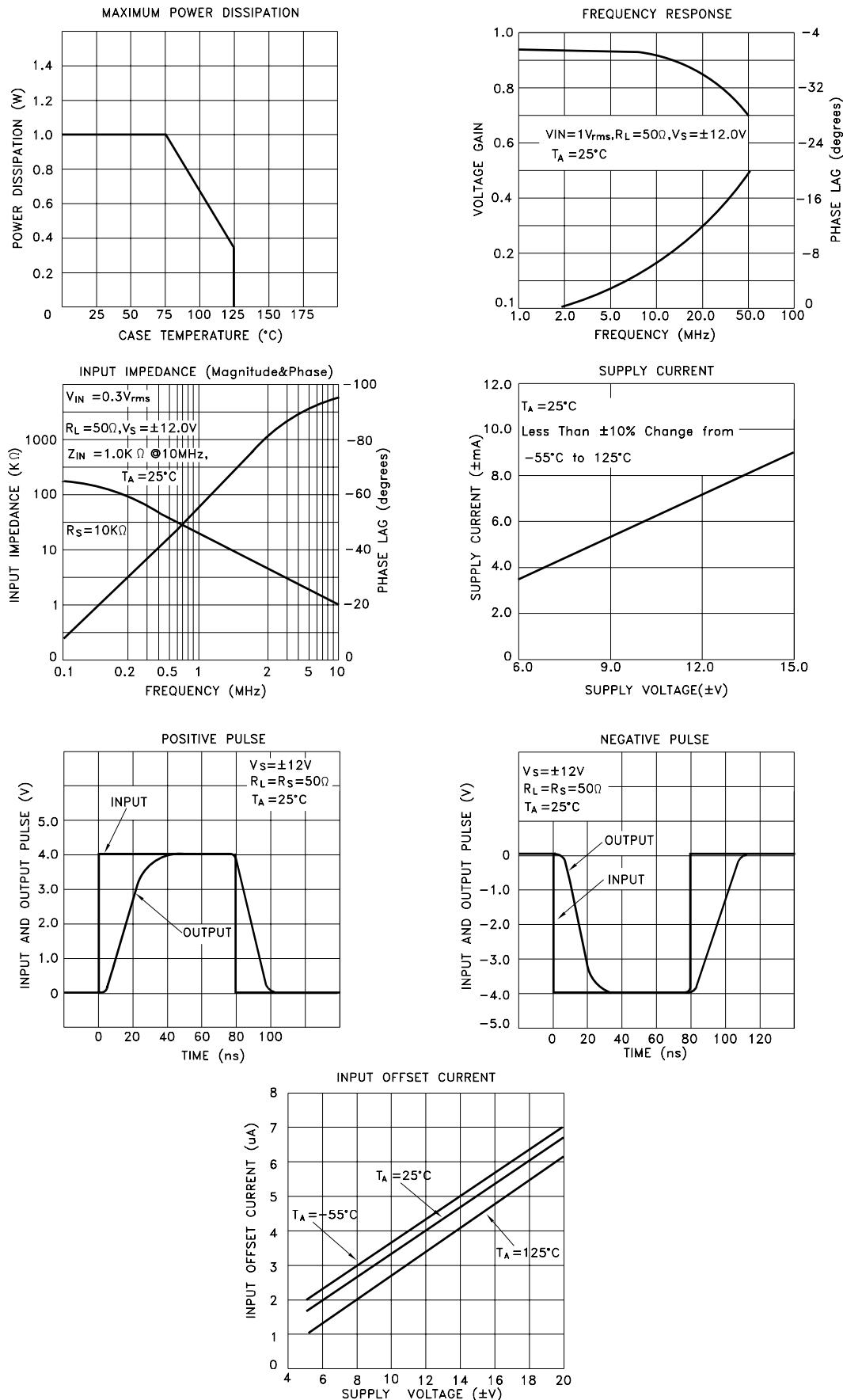
SELECT CAPACITOR TO ADJUST TIME RESPONSE OF PULSE.



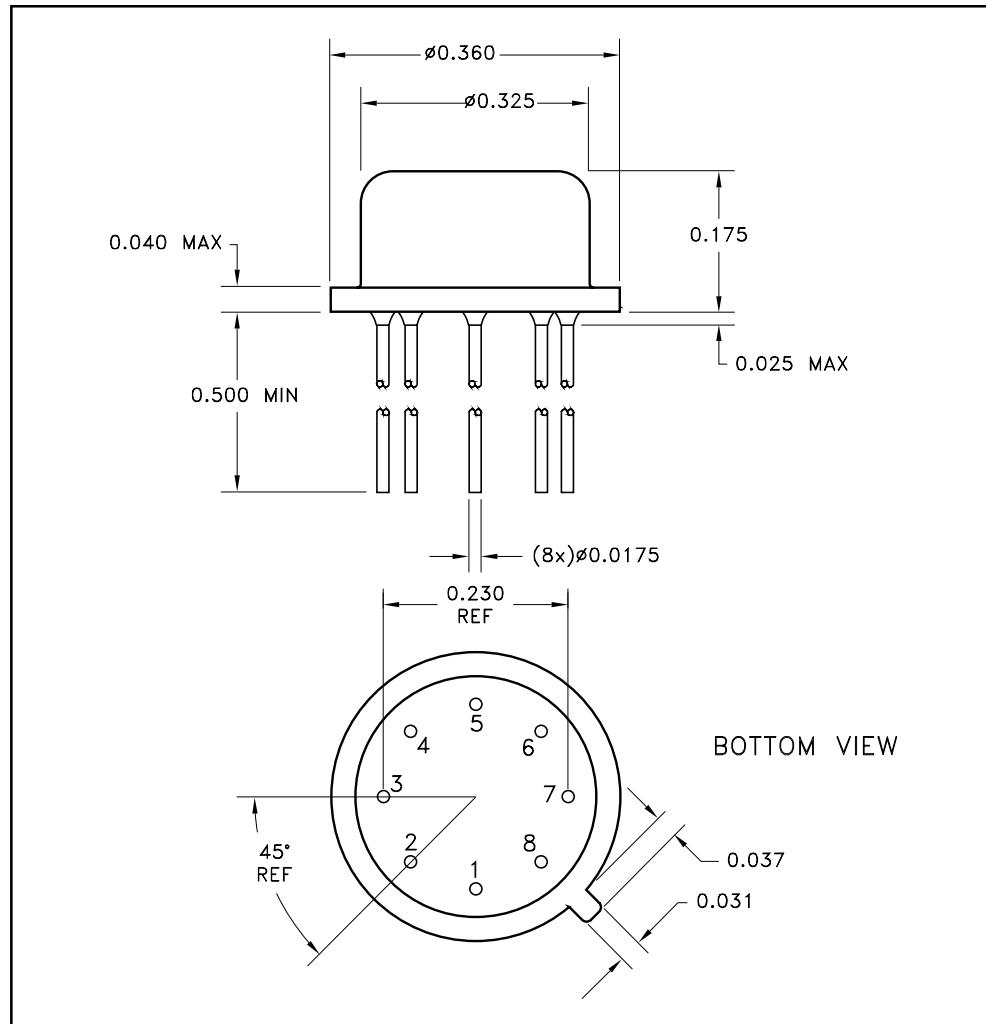
HIGH CURRENT OPERATIONAL AMPLIFIER



TYPICAL PERFORMANCE CURVES



MECHANICAL SPECIFICATIONS



ORDERING INFORMATION

Part Number	Screening Level
MSK0002	Industrial
MSK0002H	Military-Mil-PRF-38534
7801-301XC	DSCC-SMD

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